

- ★ Super Low Gate Charge
- ★ Green Device Available
- ★ Excellent Cdv/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary



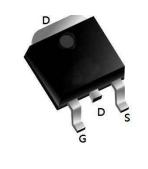
BVDSS	RDSON	ID		
100V	15mΩ	50A		

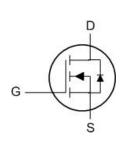
Description

The XR50N10H is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The XR50N10H meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

TO252-3L Pin Configuration





Absolute Maximum Ratings (T_C=25℃ unless otherwise specified)

Symbol	Parameter		Max.	Units
V _{DSS}	Drain-Source Voltage		100	V
V _{GSS}	Gate-Source Voltage		±25	V
1	Continuous Drain Current	T _C = 25°C	59	А
I _D C		T _C = 100°C	38	А
I _{DM}	Pulsed Drain Current note1		236	А
E _{AS}	Single Pulsed Avalanche Energy note2		110	mJ
P_D	Power Dissipation	T _C = 25°C	153	W
R ₀ JC	Thermal Resistance, Junction to Case		0.98	°C/W
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	℃



Electrical Characteristics (TJ=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic				•	
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250µA	100	-	_	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =100V, V _{GS} =0V,	-	-	1.0	μA
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} =±25V	-	-	±100	nA
On Charac	cteristics		•	•		
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	2	3	4	V
R _{DS(on)}	Static Drain-Source on-Resistance	V _{GS} =10V, I _D =30A	-	15	20	mΩ
Dynamic (Characteristics				'	
C _{iss}	Input Capacitance)/ O5)/)/ O)/	-	5211	-	pF
Coss	Output Capacitance	V _{DS} =25V, V _{GS} =0V,	-	232	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	163	-	pF
Qg	Total Gate Charge	V -20V I -20A	-	87	-	nC
Qgs	Gate-Source Charge	V _{DS} =30V, I _D =30A, V _{GS} =10V	-	27	-	nC
Q_{gd}	Gate-Drain("Miller") Charge	VGS-10V	-	21	-	nC
Switching	Characteristics					
t _{d(on)}	Turn-on Delay Time		-	18	-	ns
t _r	Turn-on Rise Time	V_{DS} =30V, I_D =2A, R_L =15 Ω , R_{GEN} =2.5 Ω ,	-	8	-	ns
t _{d(off)}	Turn-off Delay Time	$V_{GS}=10V$	-	50	-	ns
t _f	Turn-off Fall Time	VGS-10V	-	20	-	ns
Drain-Sou	rce Diode Characteristics and Maxim	um Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current			-	59	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	236	Α
V_{SD}	Drain to Source Diode Forward Voltage V _{GS} =0V, I _S =59.		-	-	1.2	V
trr	Body Diode Reverse Recovery Time	Body Diode Reverse Recovery Time		32	-	ns
Qrr	Body Diode Reverse Recovery Charge	T _J = 25℃ I _F =28A,dI/dt=100A/μs	-	55	-	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

- 2. EAS condition: TJ=25 $^{\circ}\text{C}$, VDD=50V, VG=10V, L=0.5mH, RG=25 Ω , IAS=21A
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



Typical Performance Characteristics

Figure1: Output Characteristics

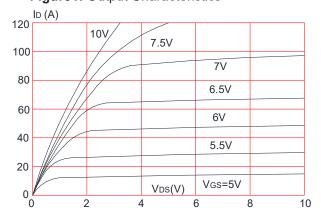


Figure 3:On-resistance vs. Drain Current

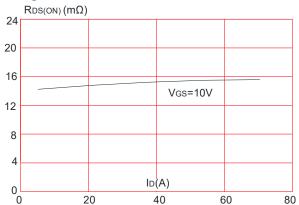


Figure 5: Gate Charge Characteristics

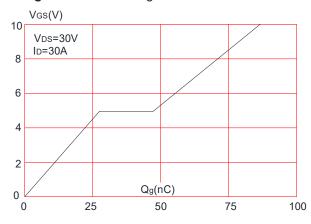


Figure 2: Typical Transfer Characteristics

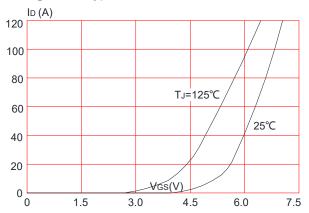


Figure 4: Body Diode Characteristics

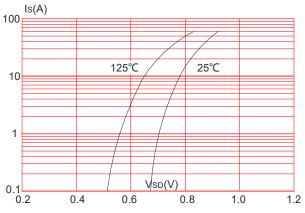


Figure 6: Capacitance Characteristics

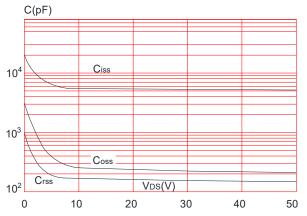




Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

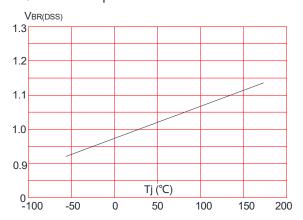


Figure 9: Maximum Safe Operating Area

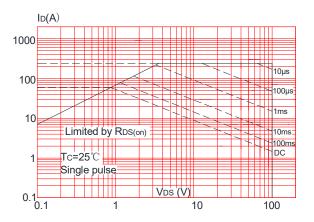


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

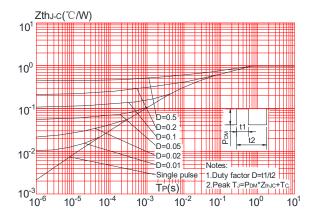


Figure 8: Normalized on Resistance vs. Junction Temperature

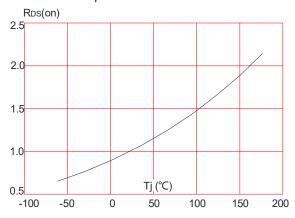
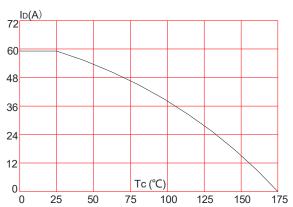


Figure 10: Maximum Continuous Drain Current vs. Case Temperature





Test Circuit

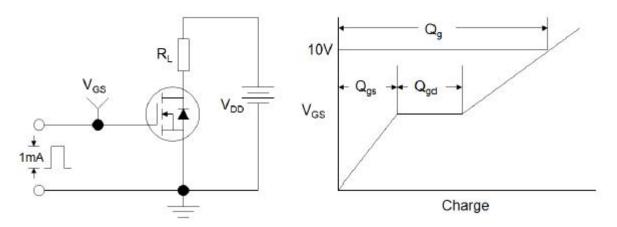


Figure1:Gate Charge Test Circuit & Waveform

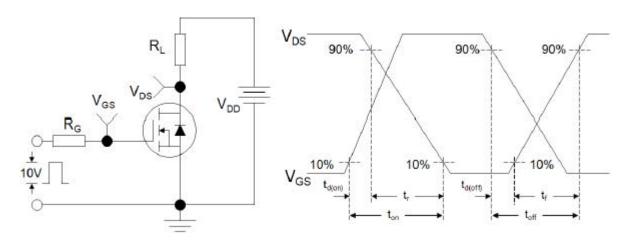


Figure 2: Resistive Switching Test Circuit & Waveforms

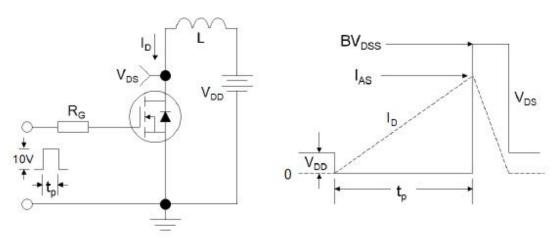
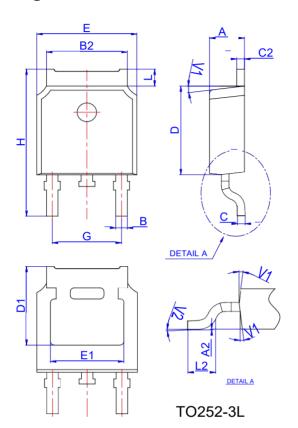


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms

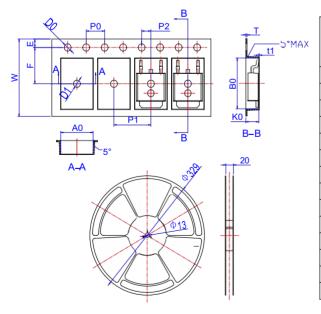


Package Mechanical Data TO252-3L



	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	2.10		2.50	0.083		0.098	
A2	0		0.10	0		0.004	
В	0.66		0.86	0.026		0.034	
B2	5.18		5.48	0.202		0.216	
С	0.40		0.60	0.016		0.024	
C2	0.44		0.58	0.017		0.023	
D	5.90		6.30	0.232		0.248	
D1	5.30REF			0.209REF			
E	6.40		6.80	0.252		0.268	
E1	4.63			0.182			
G	4.47		4.67	0.176		0.184	
Н	9.50		10.70	0.374		0.421	
L	1.09		1.21	0.043		0.048	
L2	1.35		1.65	0.053		0.065	
V1		7°			7°		
V2	0°		6°	0°		6°	

Reel Spectification-TO252-3L



	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
W	15.90	16.00	16.10	0.626	0.630	0.634	
Е	1.65	1.75	1.85	0.065	0.069	0.073	
F	7.40	7.50	7.60	0.291	0.295	0.299	
D0	1.40	1.50	1.60	0.055	0.059	0.063	
D1	1.40	1.50	1.60	0.055	0.059	0.063	
P0	3.90	4.00	4.10	0.154	0.157	0.161	
P1	7.90	8.00	8.10	0.311	0.315	0.319	
P2	1.90	2.00	2.10	0.075	0.079	0.083	
A0	6.85	6.90	7.00	0.270	0.271	0.276	
В0	10.45	10.50	10.60	0.411	0.413	0.417	
K0	2.68	2.78	2.88	0.105	0.109	0.113	
Т	0.24		0.27	0.009		0.011	
t1	0.10			0.004			
10P0	39.80	40.00	40.20	1.567	1.575	1.583	